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**Trust** 

Hardwork

Warmth

# **Specification**

Customer:东莞市五株电子科技有限公司 Product appellation: Halogen Free Polyimide Film laminated board Material spec: CMT300XMM1

Customer :

Engineering	Quality Control	Purchase

# **Company** : Grace Electron Corp.(GUANG ZHOU)

## **Department** : FCCL Department

Quality Control	Engineering	Sale

Date : 2012.12.13 Version : 01

## **ONE** • Application :

This specification form is applied to Halogen Free Polyimide Film laminated board that

东莞市五株电子科技 Co., Itd Advanced Technology Inc., purchased from Grace Electron Corp.

to uses for protecting FPC purpose. The manufacturer is FCCL Dept. of Grace Electron Corp.

#### **TWO \ Product Codes :**



### **THREE < SIZE**

#### CMT300XMM1

Characteristic	Unit	Conditioning	Standard	Test Method
Solder Float Resistance		300°C/10sec	No Change in Appearance	IPC-TM-650 2.4.13

# 

#### **CMT300XMM1**

Item		Size	Standard
Total Thickness		75	±3um
Width(mm)		250	±0.5mm
Length(m)		50	-0 +1.0m
Aberrant marks		Indemnify 0.5m/ Splice	$\leq 2$ Splices/Roll
Appearance Voids	Inclusions voids	inclusions  Pits and dents  voids  discoloration: 0.13~0.50mm (as one dot) 0.51~1.00mm (as two dot) Above 1.00mm is not allowed	≤15 dot (No precept)
	Pits and dents		
	Copper spot		Normal vision≦10 Splices/Roll

# FIVE Test Method

#### 1. Solder Float Resistance----- Refer to IPC-TM-650, Method 2..4.13

1-1 Making specimen : The same specimen with Peel Strength

1-2 Test equipment : Solder Pot

1-3 Test process :

Cutter to prepare approximately  $5 \times 5$  cm specimen with roasted ,immerse solder pot and observe appearance. 1-4 Standard : No change in Appearance

# SIX Storage Condition

1. Vacuum Packaging: Below 30°C for 12months

2.Normal Packaging : Below 30°C , below 70% RH for 12months

# **SEVEN < Environmental Management Material**

The product in accord with Sony SS-00259 and ROHS normal